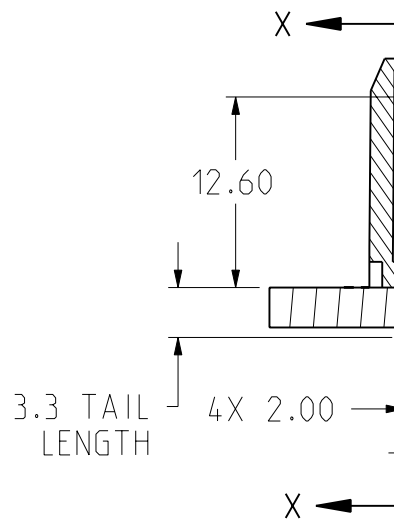
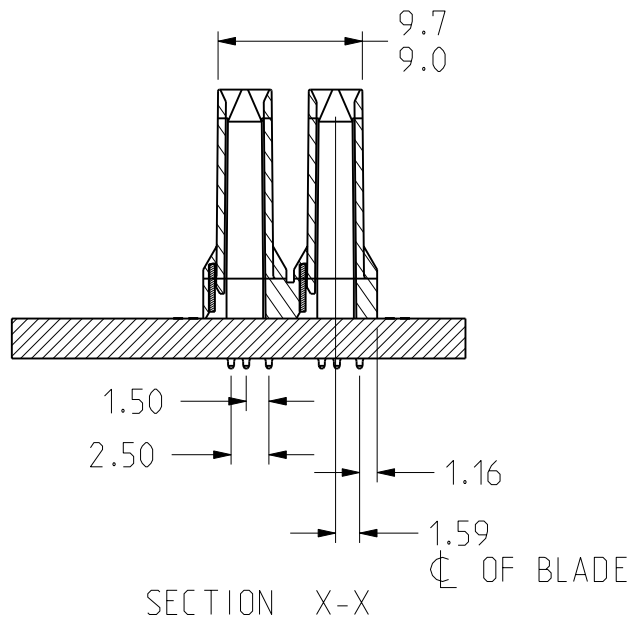


TABLE 2

PART NUMBER	INSULATOR	CONTACT NUMBER	COLOR	PLATING DESCRIPTION
437-5062-000	437-0038-060	265-0000-735	BLACK	Ni SULFAMATE, STANDARD GOLD, LEADED
437-5061-000	437-0038-070	265-0000-732	GREY	Ni SULFAMATE, HIGH GOLD, LEADED
437-6062-000	437-0038-060	265-0000-769	BLACK	Ni SULFAMATE, STANDARD GOLD, LEAD-FREE
437-6061-000	437-0038-070	265-0000-768	GREY	Ni SULFAMATE, HIGH GOLD, LEAD-FREE
437-5762-000	437-0038-060	265-0000-804	BLACK	NANO Ni, STANDARD GOLD, LEADED
437-5761-000	437-0038-070	265-0000-803	GREY	NANO Ni, HIGH GOLD, LEADED
437-6762-000	437-0038-060	265-0000-806	BLACK	NANO Ni, STANDARD GOLD, LEAD-FREE
437-6761-000	437-0038-070	265-0000-805	GREY	NANO Ni, HIGH GOLD, LEAD-FREE

6 ROW VHDM DAUGHTERCARD
POWER MODULE CONFIGURATION
SHOWN FOR REFERENCE ONLY



NOTES:

1. FOR EACH ADDITIONAL POWER MODULE ADD 12.00MM.
2. FOR HASL FINISHES SEE ACTS TECHNICAL BULLETIN, TB2040, FOR SOLDER SAG ALLOWANCE OPPOSITE CONNECTOR SIDE
3. KEEP OUT ZONE FOR SURFACE TRACES.
4. PART MARKING AS FOLLOWS:
 LINE 1: DATE CODE (YYWW)
 LINE 2-3: WORK ORDER NUMBER (*#####),
 WHERE (*) DENOTES MANUFACTURING LOCATION.

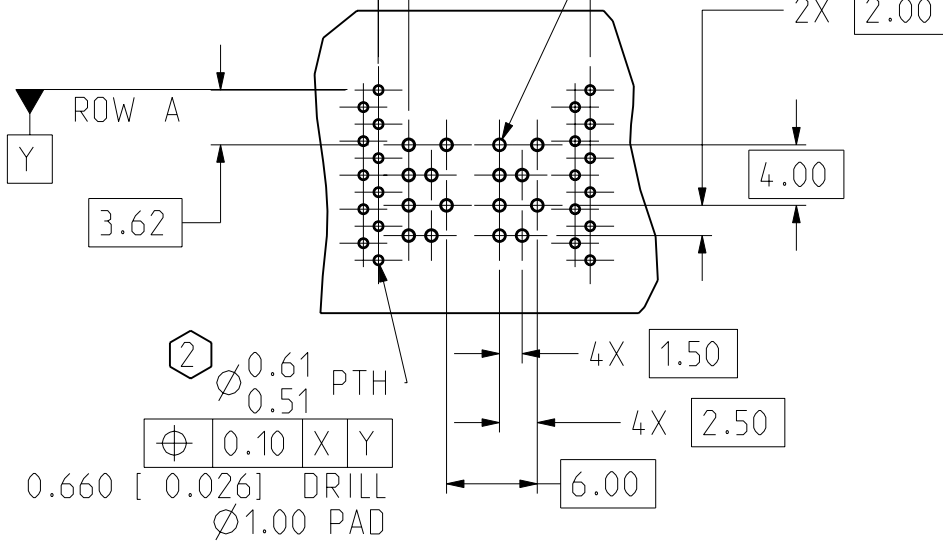
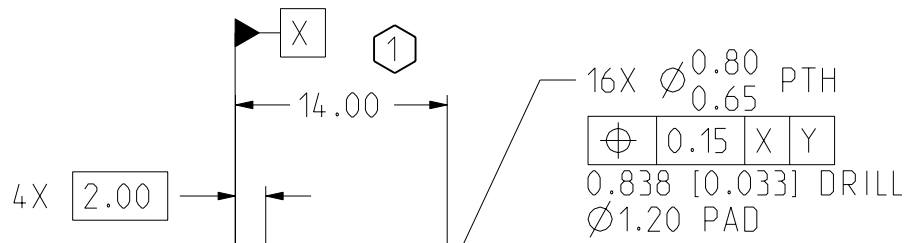
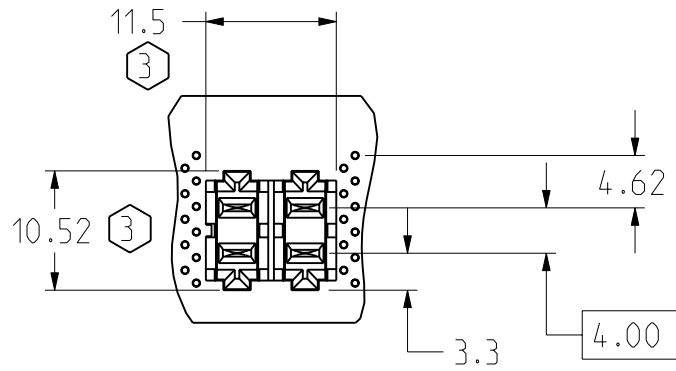
4

3

6 ROW VHDM CONFIGURATION

6 ROW VHDM

B



BACKPLANE HOLE PATTERN
POWER MODULE
CONNECTOR SIDE
6 ROW VHDM WAFER

A

ROW A
Y

$\varnothing 0.61$
0.51
 $\varnothing 0.10$
0.660[0.026]
 $\varnothing 1.00$

BACKPLANE
POWER
CONNECTOR
6 ROW VHDM

4

3

